



**VPX4812**

**Single-Slot 3U VPX Bus  
XMC Carrier Card with P16 Support  
VPX Switch Card**

**USER'S MANUAL**

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#### **IMPORTANT SAFETY CONSIDERATIONS**

**It is very important for the user to consider the possible adverse effects of power, wiring, component, sensor, or software failures in designing any type of control or monitoring system. This is especially important where economic property loss or human life is involved. It is important that the user employ satisfactory overall system design. It is agreed between the Buyer and Acromag, that this is the Buyer's responsibility.**

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## 1.0 General Information

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The VPX4812 is an XMC Carrier Card Module in the 3U VPX form factor, targeted for processing, communications, and display applications in the commercial, military, and aerospace markets.

The VPX4812 provides support for Rear I/O connections from the XMC P16 connector. The TRANS-V112 is the Rear Transition Module for the VPX4812 used to bring out Rear I/O connections through the backplane.

The VPX4812 supports up to four VPX Fat Pipe (x4) connections to other cards in the system at Gen 2.0 speeds. The VPX4812 can be used as a switch card allowing an upstream Fat Pipe or Double Fan Pipe connection – typically to a CPU – to communicate with up to three downstream Fat Pipe connections or a single Double Fat Pipe connection.

The VPX4812 also provides support for a VPX Double Fat Pipe (x8) connection to an XMC card at Gen 2.0 speeds.

### Key Features

- 24-Channel 5-Port PCI Express Gen. 2.0 Switch
- The XMC site is PCIe 8-Lanes Gen. 2.0
- Module conforms to VPX Spec. VITA 46.0, 46.4, and 46.9
- The XMC site supports X24s+X8d+X12d I/O mapping (VITA 46.9)
- 16 Lanes PCI Express to backplane (VITA 46.0 and 46.4)
- Supports Non-Transparent Bridging Applications
- 3U VPX form factor supporting OpenVPX/VITA 65
- Air and conduction cooled variants available
- REDI covers supporting VITA 48 available

## Introduction

The VPX4812 has two primary functions that can be utilized in a VPX system simultaneously.

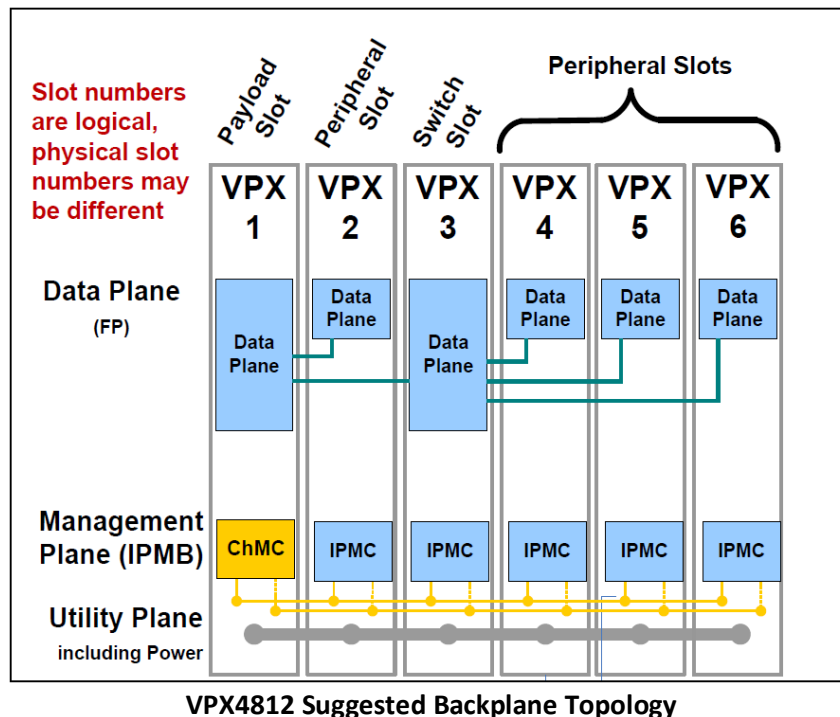
1. XMC Carrier Card – The VPX4812 supports a Double Fat Pipe (x8) connection from an XMC module to the on-board PCIe switch. The voltage used to power the XMC module can be toggled between 5V or 12V using a DIP switch located on the VPX4812.
2. VPX Switch Card – The VPX4812 contains a 24-lane 5-port PCIe switch capable of Gen 2.0 speeds. When utilizing the VPX4812 as a switch card, a CPU module configured to be an upstream port can communicate with up to three downstream VPX cards in the system as well as an XMC module on the 4812.

The VPX4812 supports the use of non-transparent bridging using the on-board PCIe switch. By utilizing non-transparent bridging (NTB), the VPX4812 can be used to implement multi-hosted topologies including intelligent adapter cards, dual-host systems with redundancy, and even blade server systems.

## Module and Backplane Profiles

The VPX4812 conforms to module profile MOD3-SWH-4F-16.4.5-2 of the VITA 65 specification. The VPX4812 conforms to switch slot profile SLT3-SWH-4F-14.4.4 of the VITA 65 specification.

The VPX 4812 is intended for use in backplane profiles BKP3-CEN06-15.2.12-n of the VITA 65 specification. Use of this module in an incompatible backplane profile could result in damage to this module or others in the chassis.



## Build Levels

The VPX4812 is available in three electrically compatible build levels, each of which is carefully tailored to a particular set of requirements and environments. All three levels fully support the power and versatility of VPX, so no matter how large or diversified your project, absolute compatibility is assured at all stages of development. The three build levels have three basic mechanical configurations, both in accordance with the VITA 46.0 VPX standard and the VITA 48 REDI standard:

1. Air (convection) cooled modules are intended for use in standard industrial chassis.
2. Conduction-cooled modules are intended for use in sealed Air Transportable Racking (ATR) and other conduction-cooled environments.
3. REDI cover, Conduction-cooled modules are intended for use in sealed Air Transportable Racking (ATR) and other conduction-cooled environments.

## 2.0 Ordering Information

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VPX4812 Available Models	
VPX4812-XX	Air-cooled Model
VPX4812-CC-XX	Conduction-cooled Model
VPX4812-REDI-XX	REDI
XX = Solder	
	L = Lead solder
	LF = Lead-free solder



## 3.0 Preparation For Use

### Unpacking and Inspection

Upon receipt of this product, inspect the shipping carton for evidence of mishandling during transit. If the shipping carton is badly damaged or water stained, request that the carrier's agent be present when the carton is opened.



If the carrier's agent is absent when the carton is opened and the contents of the carton are damaged, keep the carton and packing material for the agent's inspection.

For repairs to a product damaged in shipment, refer to the Acromag Service Policy to obtain return instructions. It is suggested that salvageable shipping cartons and packing material be saved for future use in the event the product must be shipped.

This board is physically protected with packing material and electrically protected with an anti-static bag during shipment. It is recommended that the board be visually inspected for evidence of mishandling prior to applying power.

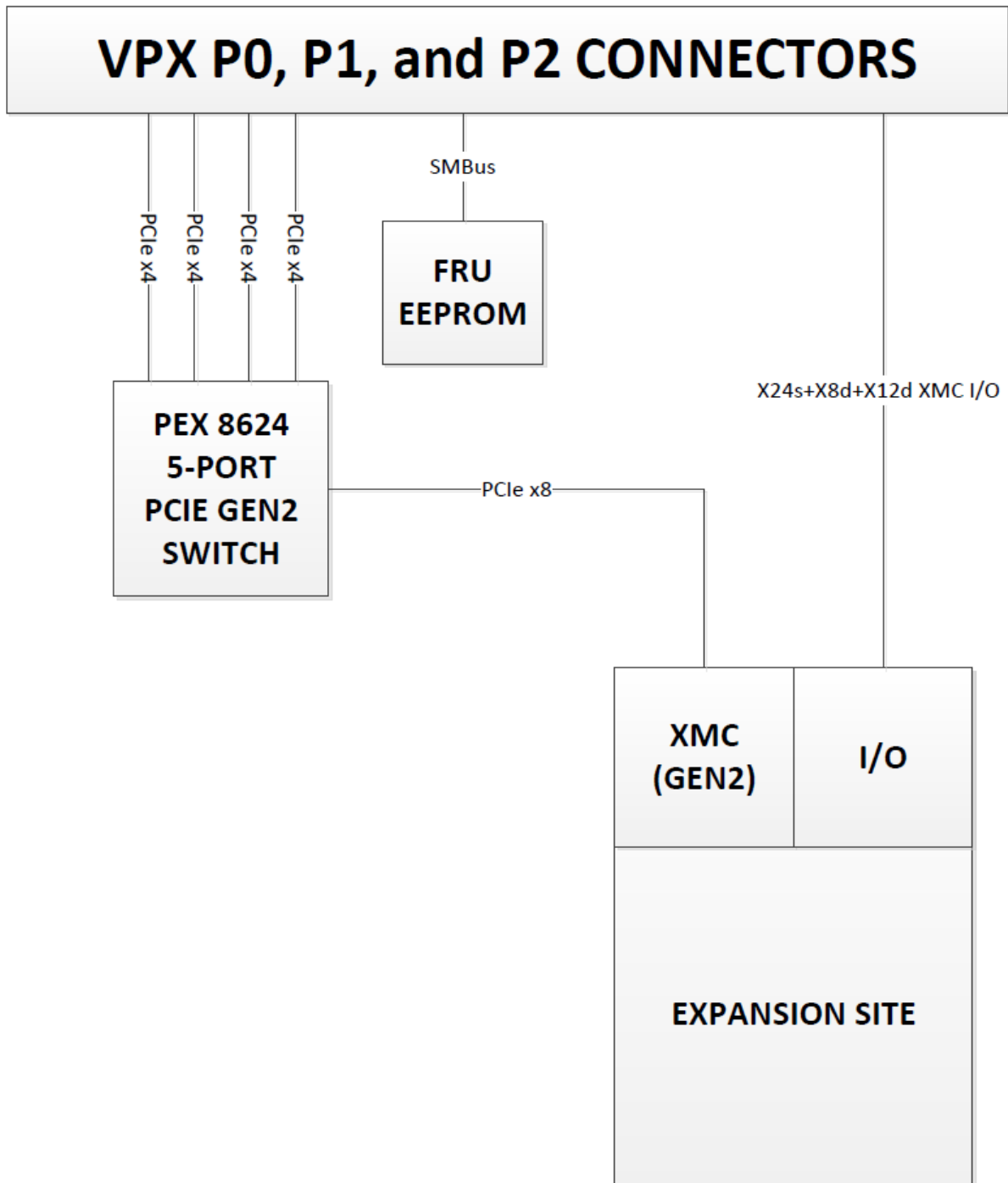
The board utilizes static sensitive components and should only be handled at a static-safe workstation.

**IMPORTANT: Adequate air circulation must be provided to prevent a temperature rise above the maximum operating temperature.**

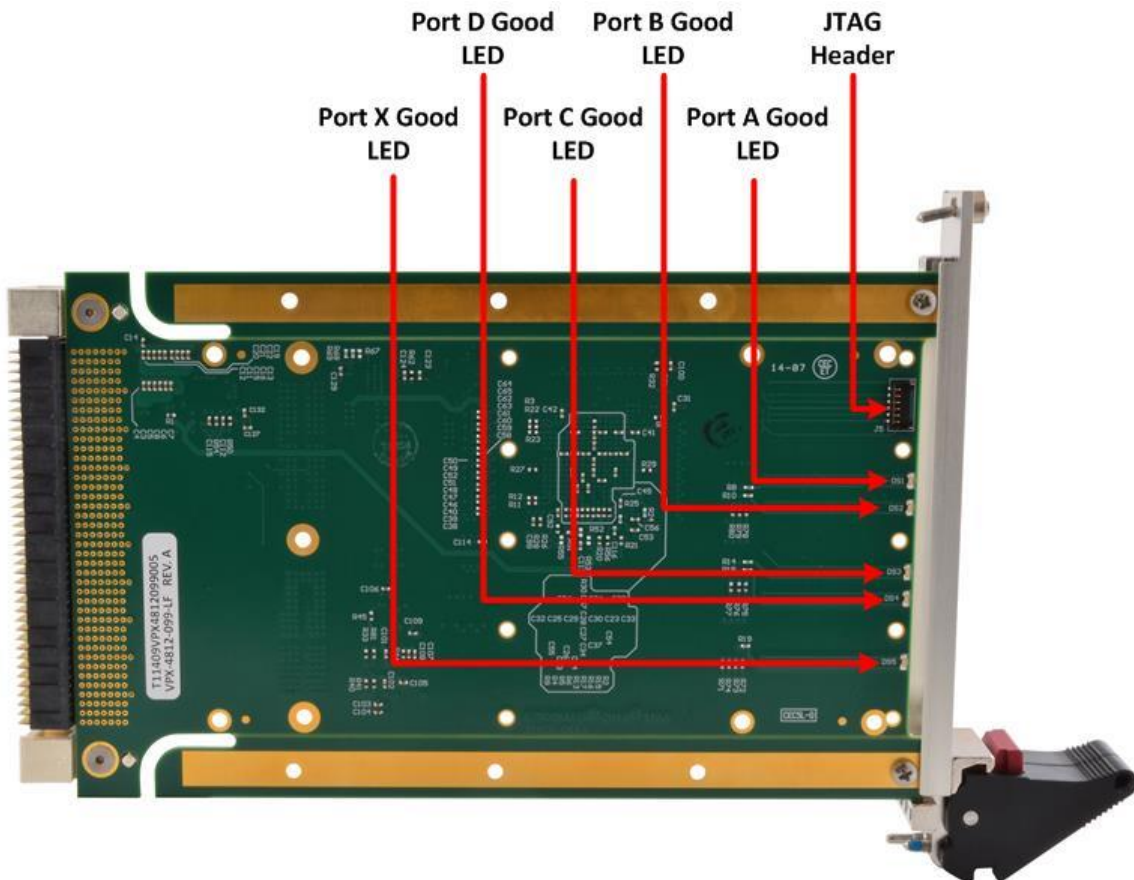
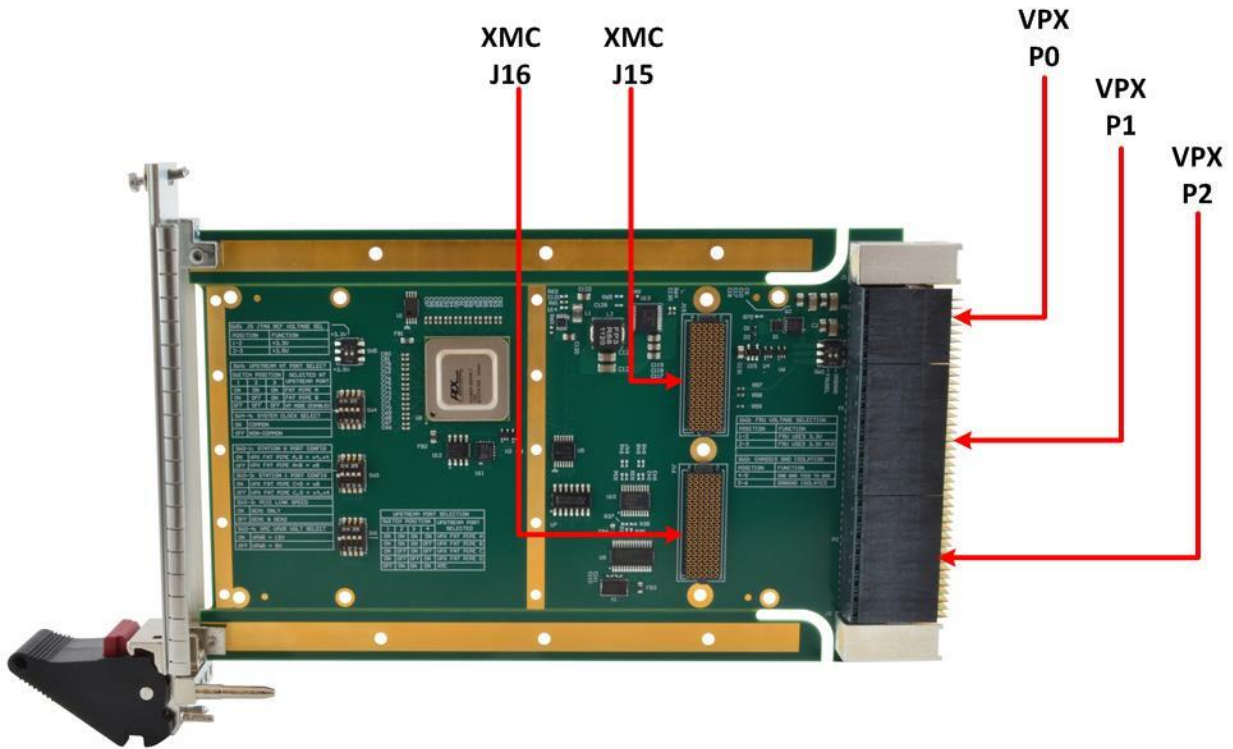
Adequate air circulation must be provided to prevent a temperature rise above the maximum operating temperature and to prolong the life of the electronics.

If the installation is in an industrial environment and the board is exposed to environmental air, careful consideration should be given to air-filtering.

### 4.0 Operational Block Diagram



### 5.0 Board Layout



## 6.0 Connectors

### P0 Connector

P0 Wafer	A	B	C	D	E	F	G
1	+3.3 V	+3.3 V	+3.3 V	Unused	+12 V	+12 V	+12 V
2	+3.3 V	+3.3 V	+3.3 V	Unused	+12 V	+12 V	+12 V
3	+5 V	+5 V	+5 V	Unused	+5 V	+5 V	+5 V
4	NVRAM_LOCK	PLT_RST#	GND	-12V_AUX	GND	Unused	Unused
5	SMB_DATA	SMB_CLK	GND	+3.3V_AUX	GND	Unused	Unused
6	GA0#	GA1#	GND	+12V_AUX	GND	GA2#	GA3#
7	Unused	Unused	GND	Unused	Unused	GND	Unused
8	GND	Unused	Unused	GND	PCIE_VPX REF_CLK P	PCIE_VPX REF_CLK N	GND

# = Low true signal

### P1 Connector

P1 Wafer	A	B	C	D	E	F	G
1	PCIE_VPX_P0_RXP	PCIE_VPX_P0_RXN	GND	PCIE_VPX_P0_TXP	PCIE_VPX_P0_TXN	GND	Unused
2	GND	PCIE_VPX_P1_RXP	PCIE_VPX_P1_RXN	GND	PCIE_VPX_P1_TXP	PCIE_VPX_P1_TXN	GND
3	PCIE_VPX_P2_RXP	PCIE_VPX_P2_RXN	GND	PCIE_VPX_P2_TXP	PCIE_VPX_P2_TXN	GND	Unused
4	GND	PCIE_VPX_P3_RXP	PCIE_VPX_P3_RXN	GND	PCIE_VPX_P3_TXP	PCIE_VPX_P3_TXN	GND
5	PCIE_VPX_P4_RXP	PCIE_VPX_P4_RXN	GND	PCIE_VPX_P4_TXP	PCIE_VPX_P4_TXN	GND	Unused
6	GND	PCIE_VPX_P5_RXP	PCIE_VPX_P5_RXN	GND	PCIE_VPX_P5_TXP	PCIE_VPX_P5_TXN	GND
7	PCIE_VPX_P6_RXP	PCIE_VPX_P6_RXN	GND	PCIE_VPX_P6_TXP	PCIE_VPX_P6_TXN	GND	Unused
8	GND	PCIE_VPX_P7_RXP	PCIE_VPX_P7_RXN	GND	PCIE_VPX_P7_TXP	PCIE_VPX_P7_TXN	GND
9	PCIE_VPX_P8_RXP	PCIE_VPX_P8_RXN	GND	PCIE_VPX_P8_TXP	PCIE_VPX_P8_TXN	GND	Unused
10	GND	PCIE_VPX_P9_RXP	PCIE_VPX_P9_RXN	GND	PCIE_VPX_P9_TXP	PCIE_VPX_P9_TXN	GND
11	PCIE_VPX_P10_RXP	PCIE_VPX_P10_RXN	GND	PCIE_VPX_P10_TXP	PCIE_VPX_P10_TXN	GND	Unused
12	GND	PCIE_VPX_P11_RXP	PCIE_VPX_P11_RXN	GND	PCIE_VPX_P11_TXP	PCIE_VPX_P11_TXN	GND
13	PCIE_VPX_P12_RXP	PCIE_VPX_P12_RXN	GND	PCIE_VPX_P12_TXP	PCIE_VPX_P12_TXN	GND	Unused
14	GND	PCIE_VPX_P13_RXP	PCIE_VPX_P13_RXN	GND	PCIE_VPX_P13_TXP	PCIE_VPX_P13_TXN	GND
15	PCIE_VPX_P14_RXP	PCIE_VPX_P14_RXN	GND	PCIE_VPX_P14_TXP	PCIE_VPX_P14_TXN	GND	Unused
16	GND	PCIE_VPX_P15_RXP	PCIE_VPX_P15_RXN	GND	PCIE_VPX_P15_TXP	PCIE_VPX_P15_TXN	GND

**RX** is defined as a signal that is an input to the VPX4812.

**TX** is defined as a signal that is an output from the VPX4812.

## P2 Connector

P2 Wafer	A	B	C	D	E	F	G
1	J16_SIO11_P	J16_SIO11_N	GND	J16_SIO10_P	J16_SIO10_N	GND	Unused
2	GND	J16_SIO9_P	J16_SIO9_N	GND	J16_SIO8_P	J16_SIO8_N	GND
3	J16_SIO7_P	J16_SIO7_N	GND	J16_SIO6_P	J16_SIO6_N	GND	Unused
4	GND	J16_SIO5_P	J16_SIO5_N	GND	J16_SIO4_P	J16_SIO4_N	GND
5	J16_SIO3_P	J16_SIO3_N	GND	J16_SIO2_P	J16_SIO2_N	GND	Unused
6	GND	J16_SIO1_P	J16_SIO1_N	GND	J16_SIO0_P	J16_SIO0_N	GND
7	J16_DP01_N	J16_DP01_P	GND	J16_DP00_N	J16_DP00_P	GND	Unused
8	GND	J16_DP03_N	J16_DP03_P	GND	J16_DP02_N	J16_DP02_P	GND
9	J16_DP11_N	J16_DP11_P	GND	J16_DP10_N	J16_DP10_P	GND	Unused
10	GND	J16_DP13_N	J16_DP13_P	GND	J16_DP12_N	J16_DP12_P	GND
11	J16_DP05_N	J16_DP05_P	GND	J16_DP04_N	J16_DP04_P	GND	Unused
12	GND	J16_DP07_N	J16_DP07_P	GND	J16_DP06_N	J16_DP06_P	GND
13	J16_DP09_N	J16_DP09_P	GND	J16_DP08_N	J16_DP08_P	GND	Unused
14	GND	J16_DP15_N	J16_DP15_P	GND	J16_DP14_N	J16_DP14_P	GND
15	J16_DP17_N	J16_DP17_P	GND	J16_DP16_N	J16_DP16_P	GND	Unused
16	GND	J16_DP19_N	J16_DP19_P	GND	J16_DP18_N	J16_DP18_P	GND

## J15 Connector

	A	B	C	D	E	F
1	PCIE_XMC_P0_RXP	PCIE_XMC_P0_RXN	+3.3V	PCIE_XMC_P1_RXP	PCIE_XMC_P1_RXN	VPWR
2	GND	GND	NC	GND	GND	XMC_RSTI#
3	PCIE_XMC_P2_RXP	PCIE_XMC_P2_RXN	+3.3V	PCIE_XMC_P3_RXP	PCIE_XMC_P3_RXN	VPWR
4	GND	GND	JTAG_TCK	GND	GND	XMC_RSTO#
5	PCIE_XMC_P4_RXP	PCIE_XMC_P4_RXN	+3.3V	PCIE_XMC_P5_RXP	PCIE_XMC_P5_RXN	VPWR
6	GND	GND	JTAG_TMS	GND	GND	+12V
7	PCIE_XMC_P6_RXP	PCIE_XMC_P6_RXN	+3.3V	PCIE_XMC_P7_RXP	PCIE_XMC_P7_RXN	VPWR
8	GND	GND	JTAG_TDI	GND	GND	-12V_AUX
9	NC	NC	NC	NC	NC	VPWR
10	GND	GND	JTAG_TDO	GND	GND	GA0#
11	PCIE_XMC_P0_TXP	PCIE_XMC_P0_TXN	NC	PCIE_XMC_P1_TXP	PCIE_XMC_P1_TXN	VPWR
12	GND	GND	GA1#	GND	GND	NC
13	PCIE_XMC_P2_TXP	PCIE_XMC_P2_TXN	+3.3V_AUX	PCIE_XMC_P3_TXP	PCIE_XMC_P3_TXN	VPWR
14	GND	GND	GA2#	GND	GND	SMB_DATA
15	PCIE_XMC_P4_TXP	PCIE_XMC_P4_TXN	NC	PCIE_XMC_P5_TXP	PCIE_XMC_P5_TXN	VPWR
16	GND	GND	NVRAM_LOCK	GND	GND	SMB_CLK
17	PCIE_XMC_P6_TXP	PCIE_XMC_P6_TXN	NC	PCIE_XMC_P7_TXP	PCIE_XMC_P7_TXN	NC
18	GND	GND	NC	GND	GND	NC
19	PCIE_VPX REF_CLK P	PCIE_VPX REF_CLK N	NC	NC	ROOT0#	NC

**# = Low true signal**

## J16 Connector

	A	B	C	D	E	F
1	J16_DP00_P	J16_DP00_N	NC	J16_DP01_P	J16_DP01_N	NC
2	GND	GND	NC	GND	GND	NC
3	J16_DP02_P	J16_DP02_N	NC	J16_DP03_P	J16_DP03_N	NC
4	GND	GND	NC	GND	GND	NC
5	J16_DP04_P	J16_DP04_N	NC	J16_DP05_P	J16_DP05_N	NC
6	GND	GND	NC	GND	GND	NC
7	J16_DP06_P	J16_DP06_N	NC	J16_DP07_P	J16_DP07_N	NC
8	GND	GND	J16_SIO10_N	GND	GND	J16_SIO11_N
9	J16_DP08_P	J16_DP08_N	J16_SIO10_P	J16_DP09_P	J16_DP09_N	J16_SIO11_P
10	GND	GND	J16_SIO8_N	GND	GND	J16_SIO9_N
11	J16_DP10_P	J16_DP10_N	J16_SIO8_P	J16_DP11_P	J16_DP11_N	J16_SIO9_P
12	GND	GND	J16_SIO6_N	GND	GND	J16_SIO7_N
13	J16_DP12_P	J16_DP12_N	J16_SIO6_P	J16_DP13_P	J16_DP13_N	J16_SIO7_P
14	GND	GND	J16_SIO4_N	GND	GND	J16_SIO5_N
15	J16_DP14_P	J16_DP14_N	J16_SIO4_P	J16_DP15_P	J16_DP15_N	J16_SIO5_P
16	GND	GND	J16_SIO2_N	GND	GND	J16_SIO3_N
17	J16_DP16_P	J16_DP16_N	J16_SIO2_P	J16_DP17_P	J16_DP17_N	J16_SIO3_P
18	GND	GND	J16_SIO0_N	GND	GND	J16_SIO1_N
19	J16_DP18_P	J16_DP18_N	J16_SIO0_P	J16_DP19_P	J16_DP19_N	J16_SIO1_P

## J5 Connector – JTAG Header

Pin Number	Description
1	JTAG_TDI
2	JTAG_TDO
3	GND
4	JTAG_TCK
5	JTAG_TMS
6	JTAG_VREF

## 7.0 Switch Settings

The following describes the VPX4812 switches with their default positions and their functions.

SW1 – Upstream Port Selection				
Switch Position				Selected Upstream Port
1	2	3	4	
ON	ON	ON	ON	VPX Fat Pipe A (default)
OFF	ON	ON	ON	VPX Fat Pipe B
OFF	ON	OFF	ON	VPX Fat Pipe C
ON	OFF	OFF	ON	VPX Fat Pipe D
ON	ON	ON	OFF	XMC

<b>SW2 (FRUSEL &amp; ORBGND)</b>	<b>1-2 (default)</b>	FRU uses 3.3V
	2-3	FRU uses 3.3V_AUX
	<b>4-5 (default)</b>	Orb ground is connected to digital ground.
	5-6	Orb ground is isolated from digital ground.

*Orb ground is the front panel and the VPX key-guides.*

<b>SW3-1 (STATION 0 PORT CONFIG)</b>	<b>ON (default)</b>	VPX Fat Pipe A = x4, VPX Fat Pipe B = x4
	OFF	VPX Fat Pipe A = x8, VPX Fat Pipe B = Disabled

<b>SW3-2 (STATION 1 PORT CONFIG)</b>	ON	VPX Fat Pipe C = x8, VPX Fat Pipe D = Disabled
	<b>OFF (default)</b>	VPX Fat Pipe C = x4, VPX Fat Pipe D = x4

<b>SW3-3 (PCIE LINK SPEED)</b>	ON	Force Gen 1.0 Speed Only
	<b>OFF (default)</b>	Allow Gen 1.0 & Gen 2.0 Speeds

<b>SW3-4 (XMC VPWR VOLT SELECT)</b>	ON	VPWR = +12V
	<b>OFF (default)</b>	VPWR = +5V

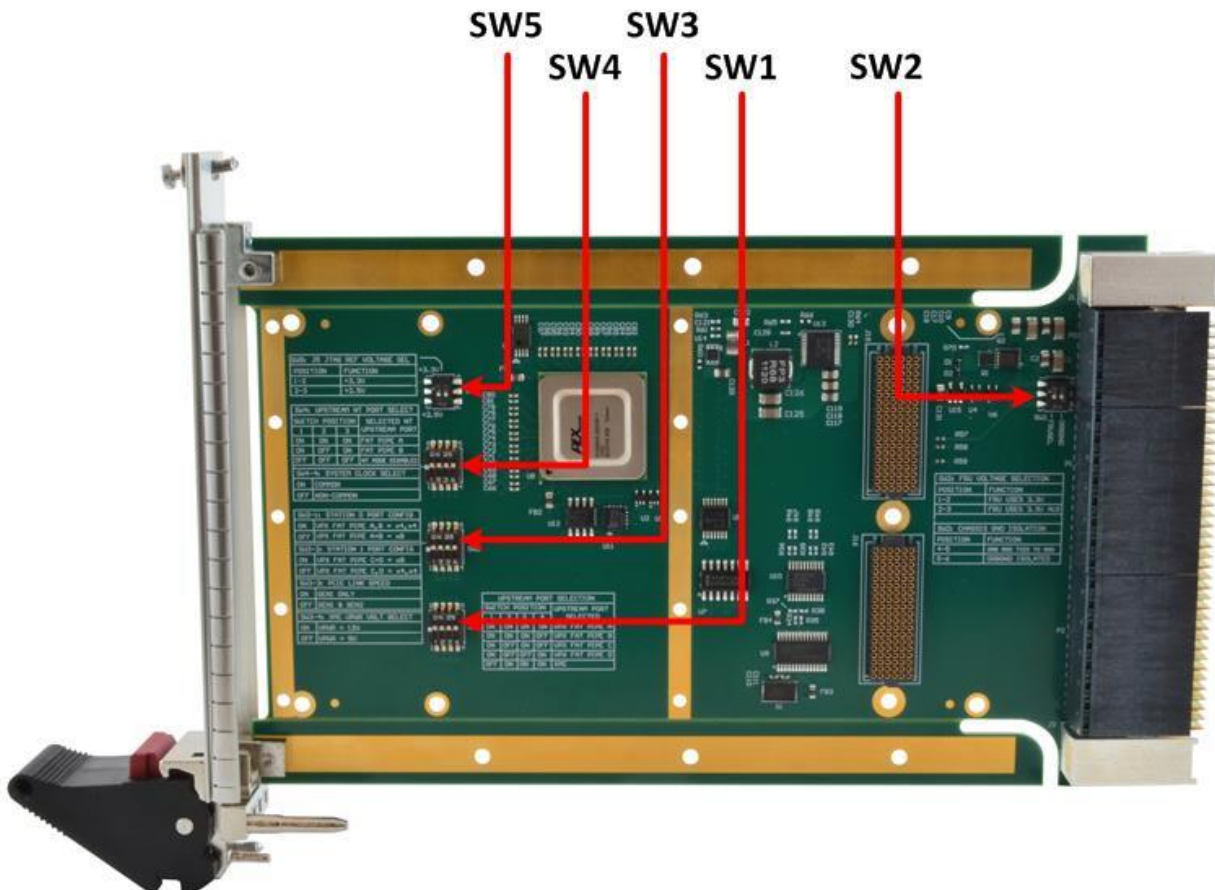
SW4-1:3 – Upstream NT Port Selection			
Switch Position			Selected NT Upstream Port
1	2	3	
ON	ON	ON	VPX Fat Pipe A
ON	OFF	ON	VPX Fat Pipe B
OFF	OFF	OFF	NT Mode Disabled (default)

**Note:** In addition to the switch configuration, there are settings for the PEX8624 that must be programmed to the on-board EEPROM device to enable Non-Transparent Mode.

<b>SW4-4 (SYSTEM CLOCK SELECT)</b>	ON	<b>(Common)</b> Uses the 100MHz reference clock pins on the VPX bus generated by the CPU board for PCIe timing. (Pins E8 & F8 on the VPX P0 connector)
	OFF (default)	<b>(Non-Common)</b> Uses the 100MHz reference clock generated on board for PCIe timing.

**Note:** Best system stability may be achieved with the use of a 100MHz common clock connection from the SBC, especially at Gen 2.0 link speeds. If the system does not provide a common clock then non-common clock mode must be used.

<b>SW5 (JTAG VREF SELECT)</b>	1-2 (default)	JTAG_VREF = +3.3V
	2-3	JTAG_VREF = +2.5V
	4-5	Unused
	5-6	Unused





**Front Panel Layout**



*VPX4812 Front Panel*

On the front panel of air-cooled VPX4812 assemblies, there are 5 port status LED's. The first four LED's indicate the PCIe link status for each of the four Fat Pipe connections to other slots on the VPX backplane. The fifth LED on the front panel indicates the PCIe link status of an XMC module connected to the VPX4812. The table below describes what the LED On/Off patterns indicate about the corresponding port states.

**Port Status LED On/Off Patterns, by State**

State	LED Pattern
Link is down	Off
Link is up, Gen 2.0 speed, all Lanes are up	On
Link is up, Gen 2.0 speed, reduced Lanes are up	Blinking, 0.5 seconds On, 0.5 seconds Off
Link is up, Gen 1.0 speed, all Lanes are up	Blinking, 1.5 seconds On, 0.5 seconds Off
Link is up, Gen 1.0 speed, reduced Lanes are up	Blinking, 0.5 seconds On, 1.5 seconds Off

## 8.0 Handling

---

Modules should be handled in ESD-safe work areas in order to prevent damage to sensitive components from electrostatic discharges. These areas must be designed and maintained to prevent ESD damage.

### ESD Safe Work Area Guidelines

1. Module should be handled at properly designated work areas only.
2. Designated ESD safe work areas must be checked periodically to ensure their continued safety from ESD. The areas should be monitored for the following:
  - a. Proper grounding methods.
  - b. Static dissipation of work surfaces.
  - c. Static dissipation of floor surfaces.
  - d. Operation of ion blowers and ion air guns.
3. Designated work areas must be kept free of static generating materials such as Styrofoam, vinyl, plastic, fabrics, or any other static generating materials.
4. Work areas must be kept clean and neat in order to prevent contamination of the work area.
5. Modules should be handled by the edges. Avoid touching component leads.

**NOTE:** *When not installed in a system, modules must be enclosed in shielded bags or boxes. There are three types of ESD protective enclosure materials this module was shipped in an approved ESD bag.*

6. Whenever handling the module the operator must be properly grounded by one of the following:
  - a. Wearing a wrist strap connected to earth ground.
  - b. Wearing heel grounders and have both feet on a static dissipative floor surface.
7. Stacking of modules should be avoided to prevent physical damage.

## 9.0 Installation

---

**IMPORTANT: The VPX4812 has been specifically design for use with 3U VPX backplanes and my not be compatible with some 6U backplanes. Plugging the board into an unsupported 6U VPX backplane may cause permanent damage.**

Consult the enclosure documentation to ensure that the VPX4812's power requirements are compatible with those supplied by the backplane.

### Board Keying

The 3U VPX backplane specification requires all backplane slots to have two guide pins: one above the J0 connector and one below the J2 connector. As well as providing correct alignment, these pins are keyed to prevent cards from being inserted into incorrect backplane slot(s) to avoid electrical incompatibility.

The VPX4812 has receptacles for these guide pins (see the Connectors section). By default, these are not keyed. Please contact the factory to discuss keying requirements.

### Installation Notes

1. Keying may dictate the backplane slot(s) into which the VPX4812 can be inserted.
2. Air-cooled versions have an ejector handle to ensure that the backplane connectors mate properly with the backplane. The captive screws at the top and bottom of the front panel allow the VPX4812 to be tightly secured in position, which provides continuity with system chassis ground.
3. Conduction-cooled and REDI versions have screw driven wedge locks at the top and bottom of the board to provide the necessary mechanical/thermal interface. Correct adjustment requires a calibrated torque wrench set to between 0.6 and 0.8 Nm.

## 10.0 Specifications

### Physical

Height:	100.00 mm (3.937 in.)
Width:	160.00 mm (6.299 in.)
Board Thickness:	1.575 mm (0.062 in.)
Unit Weight (air-cooled):	5.10 Oz (0.14 Kg)
Unit Weight (conduction-cooled):	8.34 Oz (0.24 Kg)
Unit Weight (REDI):	12.37 Oz (0.35 Kg)

### Power Requirements

The VPX4812 requires +3.3V and +5V from the VPX backplane. The +/-12V supplies are used only if required by the XMC module.

### Power Consumption

No XMC Card Installed:

<b>+3.3V:</b>	<1W
<b>+5V:</b>	2.62W typ. 5.43W max
<b>+12V:</b>	0W

XMC Card Installed:

<b>+3.3V:</b>	<1W
<b>+5V:</b>	80.43W max (VPWR = 5V) 5.43W max (VPWR = 12V)
<b>+12V:</b>	0W max (VPWR = 5V) 60W max (VPWR = 12V)

**Note:** The power supplied to the XMC card can be toggled between 5V or 12V depending on the card's requirements and/or the power supply's available capacities.

### Caution

If VPWR is set to 12V, you must ensure that the XMC card is capable of handling a 12V supply voltage. If the XMC card is not capable of handling a 12V supply voltage, ensure that the VPWR switch is set to supply 5V.

**Auxiliary Supply**

The following functions may be powered from the 3.3V Auxiliary supply (VPX +3.3V\_AUX line):

FRU EEPROM  
TEMP SENSOR

**Power-Up/Reset Sequence**

From the application of 3.3V and 5V power to all components being out of reset typically takes 250ms.

Since the ramp up times of the 3.3 V and 5 V system power source and the onboard power source will vary with load, the time taken for the VPX4812 to come out of reset will vary from system to system. It is the software's responsibility to account for this.

**Bus Compliance**

Vita 46.0, 46.4, 46.9, 48 and 65  
MIL Spec 217-F MTBF – TBD

**Form Factor**

3U VPXbus 3.94" (100mm) x 6.3" (160mm)

**Flammability**

The circuit board is made by an UL recognized manufacturer and has a flammability rating of UL94V-1.

## Environmental

### Caution

The VPX4812 requires air-flow of at least 200 linear-feet/minute for the **air cooled version**, plus what is required for an XMC device installed on this module. If the **conduction cooled** version is operating on an extender card, it requires air-flow of at least 300 linear-feet/minute across it. Versions using the **REDI covers** must not be operated outside of a fully configured and fully installed conduction cooled REDI system.

ENVIRONMENTAL SPECIFICATION	OPERATING	NON-OPERATING
<b>THERMAL</b>		
<i>Air-cooled</i>	0° to 70°C*	-40° to 85°C
<i>Conduction-cooled</i>	-40° to 85°C* <sup>1</sup>	-40° to 105°C
<i>REDI Cover, Conduction-cooled</i>	-40° to 85°C* <sup>2</sup>	-40° to 105°C
<b>HUMIDITY</b>	20% - 80% RH, non-condensing	
<b>SHOCK</b>	30 g peak acceleration, 11msec duration	50 g peak acceleration, 11msec duration
<b>VIBRATION</b> 20 - 2000 Hz	.015" (.38mm) peak-to-peak displacement 2.5 g max acceleration	.030" (.76mm) peak-to-peak displacement 5.0 g max acceleration

\* w/ 200 lfm airflow

<sup>1</sup> must operate in a fully installed conduction-cooled rack

<sup>2</sup> must operate in a fully installed conduction-cooled REDI rack

## EMI/EMC Regulatory Compliance

### Caution

This module generates, uses, and can radiate electromagnetic energy. It may cause, or be susceptible to EMI if not installed and used in a cabinet with adequate EMI protection.

The VPX4812 is designed using good EMC practices and, when used in a suitably EMC-compliant chassis, should maintain the compliance of the total system.

The VPX4812 also complies with EN60950 (product safety), which is essentially the requirement for the Low Voltage Directive (73/23/EEC).

Air-cooled build levels of the VPX4812 are designed for use in systems meeting VDE class B, EN and FCC regulations for EMC emissions and susceptibility.

Conduction cooled and REDI build levels of the VPX4812 are intended for integration into EMC hardened cabinets/boxes.

## 11.0 Service and Repair

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### Service and Repair Assistance

Surface-Mounted Technology (SMT) boards are generally difficult to repair. It is highly recommended that a non-functioning board be returned to Acromag for repair. The board can be damaged unless special SMT repair and service tools are used. Further, Acromag has automated test equipment that thoroughly checks the performance of each board.

Please refer to Acromag's Service Policy Bulletin or contact Acromag for complete details on how to obtain parts and repair.

### Preliminary Service Procedure

Before beginning repair, be sure that all of the procedures in section **Error! Reference source not found.** Preparation for Use have been followed. Also, refer to the documentation of your carrier board to verify that it is correctly configured. Verify that there are no blown fuses. Replacement of the carrier and/or IP with one that is known to work correctly is a good technique to isolate a faulty board.

**CAUTION: POWER MUST BE TURNED OFF BEFORE REMOVING OR INSERTING BOARDS**

### Where to Get Help

If you continue to have problems, your next step should be to visit the Acromag worldwide web site at <http://www.acromag.com>. Our web site contains the most up-to-date product and software information.

Go to the "Support" tab to access:

- Application Notes
- Frequently Asked Questions (FAQ's)
- Product Knowledge Base
- Tutorials
- Software Updates/Drivers

An email question can also be submitted from within the Knowledge Base or directly from the "Contact Us" tab.

Acromag's application engineers can also be contacted directly for technical assistance via telephone or FAX through the numbers listed below. When needed, complete repair services are also available.

Phone: 248-295-0310

Fax: 248-624-9234

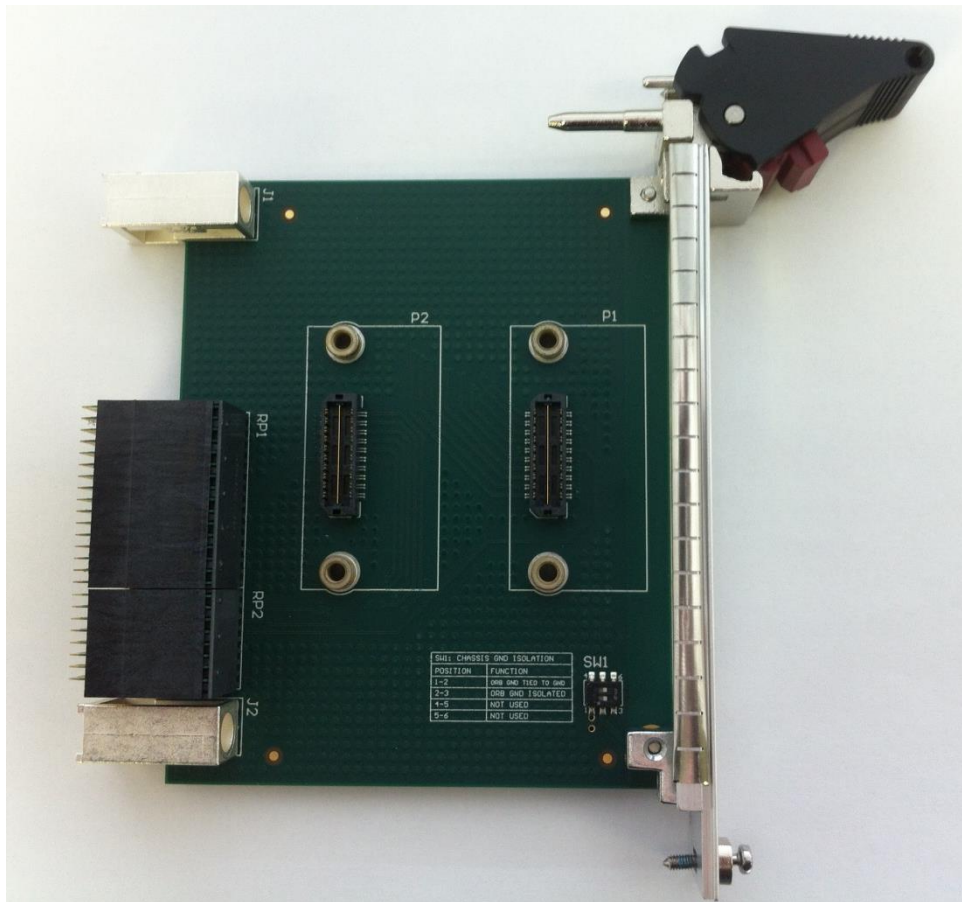
Email: [solutions@acromag.com](mailto:solutions@acromag.com)

## Appendix A – Accessory Modules

### TRANS-V112

The TRANS-V112 is the rear transition module for the VPX4812 and is used in backplanes that bring out the rear I/O signals from the VPX4812. If you are using a custom backplane, you will not need the RTM.

The TRANS-V112 brings out the P16 rear I/O signals from the XMC slot on the VPX4812. The signals are brought out by two high speed Samtec differential pair connectors (PN QTH-020-01-F-D-DP-A-K).





### Switch Settings

<b>SW1 (ORBGND)</b>	<b>1-2 (default)</b>	Orb ground is connected to digital ground.
	2-3	Orb ground is isolated from digital ground.
	4-5	Unused
	5-6	Unused

### Connectors

#### RP1 Connector

RP1 Wafer	A	B	C	D	E	F	G
1	Unused	Unused	GND	Unused	J16_SIO10_N	GND	Unused
2	GND	Unused	Unused	GND	J16_SIO8_P	J16_SIO8_N	GND
3	Unused	Unused	GND	Unused	J16_SIO6_N	GND	Unused
4	GND	Unused	Unused	GND	J16_SIO4_P	J16_SIO4_N	GND
5	Unused	Unused	GND	Unused	J16_SIO2_N	GND	Unused
6	GND	Unused	Unused	GND	J16_SIO0_P	J16_SIO0_N	GND
7	Unused	Unused	GND	Unused	J16_DP00_P	GND	Unused
8	GND	Unused	Unused	GND	J16_DP02_N	J16_DP02_P	GND
9	J16_SIO11_P	J16_SIO11_N	GND	J16_SIO10_P	Unused	GND	Unused
10	GND	J16_SIO9_P	J16_SIO9_N	GND	Unused	Unused	GND
11	J16_SIO7_P	J16_SIO7_N	GND	J16_SIO6_P	Unused	GND	Unused
12	GND	J16_SIO5_P	J16_SIO5_N	GND	Unused	Unused	GND
13	J16_SIO3_P	J16_SIO3_N	GND	J16_SIO2_P	Unused	GND	Unused
14	GND	J16_SIO1_P	J16_SIO1_N	GND	Unused	Unused	GND
15	J16_DP01_N	J16_DP01_P	GND	J16_DP00_N	Unused	GND	Unused
16	GND	J16_DP03_N	J16_DP03_P	GND	Unused	Unused	GND

#### RP2 Connector

RP2 Wafer	A	B	C	D	E	F	G
1	J16_DP11_N	J16_DP11_P	GND	J16_DP10_N	Unused	Unused	Unused
2	GND	J16_DP13_N	J16_DP13_P	GND	Unused	Unused	Unused
3	J16_DP05_N	J16_DP05_P	GND	J16_DP04_N	Unused	Unused	Unused
4	GND	J16_DP07_N	J16_DP07_P	GND	Unused	Unused	Unused
5	J16_DP09_N	J16_DP09_P	GND	J16_DP08_N	Unused	Unused	Unused
6	GND	J16_DP15_N	J16_DP15_P	GND	Unused	Unused	Unused
7	J16_DP17_N	J16_DP17_P	GND	J16_DP16_N	Unused	Unused	Unused
8	GND	J16_DP19_N	J16_DP19_P	GND	Unused	Unused	Unused
9	Unused	Unused	Unused	Unused	J16_DP10_P	GND	Unused
10	Unused	Unused	Unused	Unused	J16_DP12_N	J16_DP12_P	GND
11	Unused	Unused	Unused	Unused	J16_DP04_P	GND	Unused
12	Unused	Unused	Unused	Unused	J16_DP06_N	J16_DP06_P	GND
13	Unused	Unused	Unused	Unused	J16_DP08_P	GND	Unused
14	Unused	Unused	Unused	Unused	J16_DP14_N	J16_DP14_P	GND
15	Unused	Unused	Unused	Unused	J16_DP16_P	GND	Unused
16	Unused	Unused	Unused	Unused	J16_DP18_N	J16_DP18_P	GND

## P1 Connector

Pin Number	Description
1	J16_DPO0_P
2	J16_DPO10_P
3	J16_DPO0_N
4	J16_DPO10_N
5	J16_DPO1_P
6	J16_DPO11_P
7	J16_DPO1_N
8	J16_DPO11_N
9	J16_DPO2_P
10	J16_DPO12_P
11	J16_DPO2_N
12	J16_DPO12_N
13	J16_DPO3_P
14	J16_DPO13_P
15	J16_DPO3_N
16	J16_DPO13_N
17	J16_DPO8_P
18	J16_DPO9_P
19	J16_DPO8_N
20	J16_DPO9_N
21	J16_SIO0_P
22	J16_SIO1_P
23	J16_SIO0_N
24	J16_SIO1_N
25	J16_SIO2_P
26	J16_SIO3_P
27	J16_SIO2_N
28	J16_SIO3_N
29	J16_SIO4_P
30	J16_SIO5_P
31	J16_SIO4_N
32	J16_SIO5_N
33	J16_SIO6_P
34	J16_SIO7_P
35	J16_SIO6_N
36	J16_SIO7_N
37	J16_SIO8_P
38	J16_SIO9_P
39	J16_SIO8_N
40	J16_SIO9_N

## P2 Connector

Pin Number	Description
1	J16_DP04_P
2	J16_DP14_P
3	J16_DP04_N
4	J16_DP14_N
5	J16_DP05_P
6	J16_DP15_P
7	J16_DP05_N
8	J16_DP15_N
9	J16_DP06_P
10	J16_DP16_P
11	J16_DP06_N
12	J16_DP16_N
13	J16_DP07_P
14	J16_DP17_P
15	J16_DP07_N
16	J16_DP17_N
17	J16_DP18_P
18	J16_DP19_P
19	J16_DP18_N
20	J16_DP19_N
21	J16_SIO10_P
22	J16_SIO11_P
23	J16_SIO10_N
24	J16_SIO11_N
25	NC
26	NC
27	NC
28	NC
29	NC
30	NC
31	NC
32	NC
33	NC
34	NC
35	NC
36	NC
37	NC
38	NC
39	NC
40	NC

## Certificate of Volatility

Certificate of Volatility				
Acromag Model VPX4812-XXX-L/LF TRANS-V112-L/LF	Manufacturer: Acromag, Inc. 30765 Wixom Rd Wixom, MI 48393			
Volatile Memory				
Does this product contain Volatile memory (i.e. Memory of whose contents are lost when power is removed) <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No				
Type (SRAM, SDRAM, etc.)	Size:	User Modifiable <input type="checkbox"/> Yes <input type="checkbox"/> No	Function:	Process to Sanitize:
Type (SRAM, SDRAM, etc.)	Size:	User Modifiable <input type="checkbox"/> Yes <input type="checkbox"/> No	Function:	Process to Sanitize:
Non-Volatile Memory				
Does this product contain Non-Volatile memory (i.e. Memory of whose contents is retained when power is removed) <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No				
Type (EEPROM, Flash, etc.) EEPROM – AT25640B	Size: 64-KB	User Modifiable <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No	Function: Store settings for PEX8624 PCIe switch	Process to Sanitize: Device can be accessed via SPI through the PEX8624. Device can be sanitized by writing 0's to all bits.
Type (EEPROM, Flash, etc.) EEPROM – PCA9500BS	Size: 2-kbit	User Modifiable <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No	Function: Misc. storage	Process to Sanitize: Device can be accessed via SMBus on host CPU. Device can be sanitized by writing 0's to all bits.
Type (EEPROM, Flash, etc.)	Size:	User Modifiable <input type="checkbox"/> Yes <input type="checkbox"/> No	Function:	Process to Sanitize:
Other capabilities: Does device contain media storage capabilities: <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No    If yes explain Is this device capable of wireless transmission: <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No    If yes explain				
Acromag Representative				
Name: Joseph Primeau	Title: Dir. of Sales and Marketing	Email: solutions@acromag.com	Office Phone: 248-624-1541	Office Fax: 248-624-9234

## Revision History

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The following table shows the revision history for this document:

<b>Release Date</b>	<b>Version</b>	<b>EGR/DOC</b>	<b>Description of Revision</b>
4/25/2014	A	MDW	Initial Acromag release.